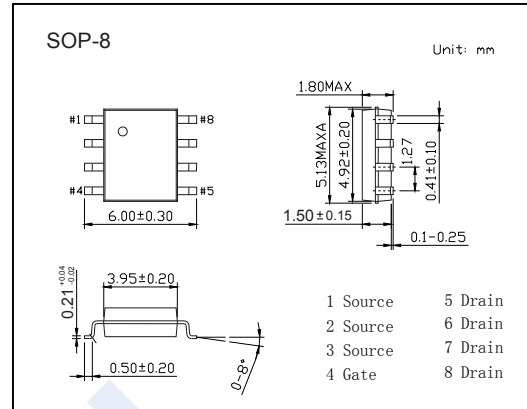
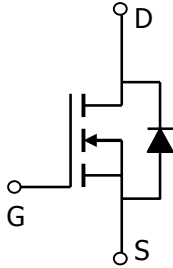


N-Channel MOSFET

AO4466 (KO4466)

■ Features

- $V_{DS} (V) = 30V$
- $I_D = 9.4 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 23m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 35m\Omega (V_{GS} = 4.5V)$



■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	$T_A=25^\circ C$	A
		$T_A=70^\circ C$	
Pulsed Drain Current	I_{DM}	50	
Power Dissipation	P_D	$T_A=25^\circ C$	W
		$T_A=70^\circ C$	
Thermal Resistance.Junction- to-Ambient	R_{thJA}	$t \leq 10s$	$^\circ C/W$
		Steady-State	
Thermal Resistance.Junction- to-Lead	R_{thJL}	24	
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 to 150	

N-Channel MOSFET

AO4466 (KO4466)

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit	
Drain-Source Breakdown Voltage	V _{DSS}	I _D =250μA, V _{GS} =0V	30			V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =24V, V _{GS} =0V			1	μA	
		V _{DS} =24V, V _{GS} =0V, T _J =55°C			5		
Gate-Body Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1		3	V	
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =9.4A			23	mΩ	
		V _{GS} =10V, I _D =9.4A, T _J =125°C			30		
		V _{GS} =4.5V, I _D =5A			35		
On State Drain Current	I _{D(ON)}	V _{GS} =4.5V, V _{DS} =5V	20			A	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =9.4A	10	24		S	
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =15V, f=1MHz		621	820	pF	
Output Capacitance	C _{oss}			118			
Reverse Transfer Capacitance	C _{rss}			85			
Gate Resistance	R _g	V _{GS} =0V, V _{DS} =0V, f=1MHz		0.8	1.5	Ω	
Total Gate Charge (10V)	Q _g	V _{GS} =10V, V _{DS} =15V, I _D =9.4A		11.3	17	nC	
Total Gate Charge (4.5V)				5.7	8		
Gate Source Charge			Q _{gs}		2.1		
Gate Drain Charge			Q _{gd}		3		
Turn-On DelayTime	t _{d(on)}	V _{GS} =10V, V _{DS} =15V, R _L =1.6Ω, R _{GEN} =3Ω		4.5	6.5	ns	
Turn-On Rise Time	t _r			3.1	5		
Turn-Off DelayTime	t _{d(off)}			15.1	23		
Turn-Off Fall Time	t _f			2.7	5		
Body Diode Reverse Recovery Time	t _{rr}	I _F = 9.4A, di/dt = 100A/μs		15.5	21	nC	
Body Diode Reverse Recovery Charge	Q _{rr}			7.1	10		
Maximum Body-Diode Continuous Current	I _S				4.3	A	
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V			1	V	

Note : The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

■ Marking

Marking	4466
	KC****

N-Channel MOSFET AO4466 (KO4466)

■ Typical Characteristics

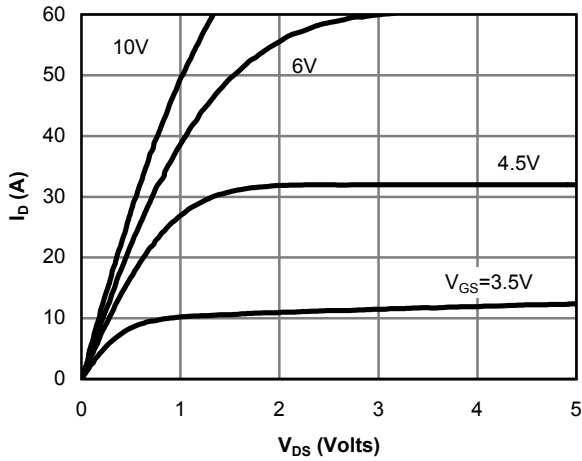


Fig 1: On-Region Characteristics

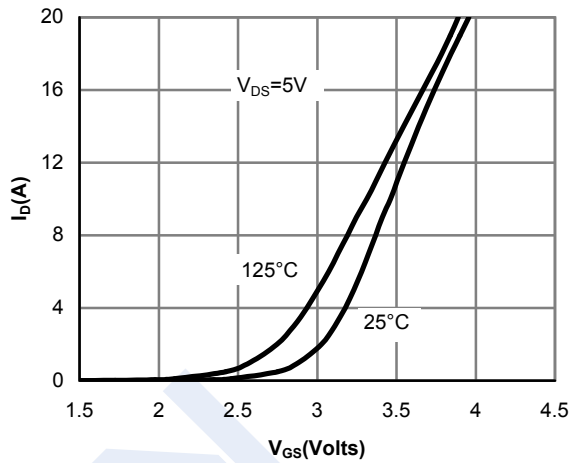


Figure 2: Transfer Characteristics

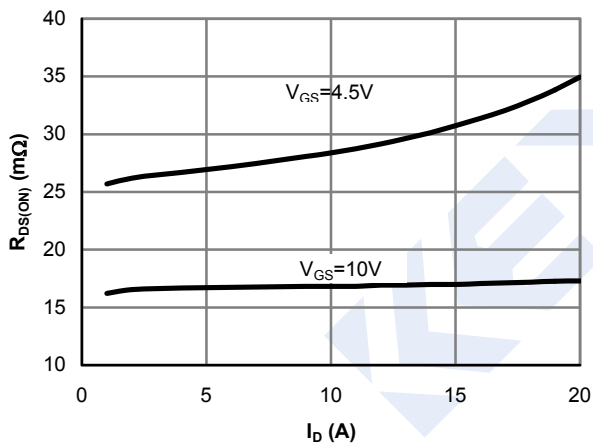


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

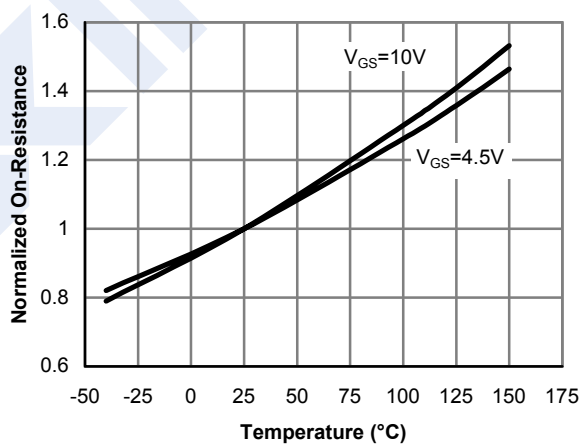


Figure 4: On-Resistance vs. Junction Temperature

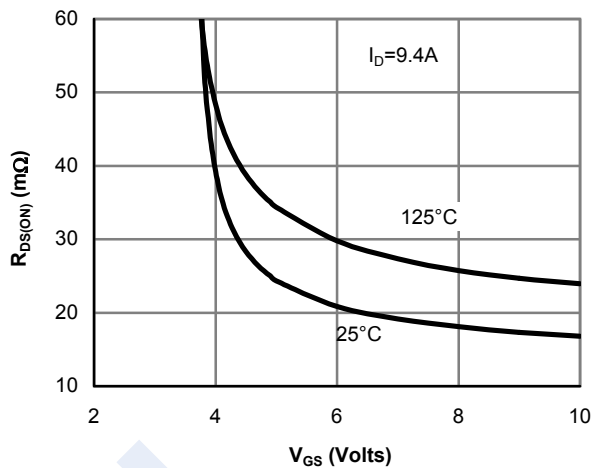


Figure 5: On-Resistance vs. Gate-Source Voltage

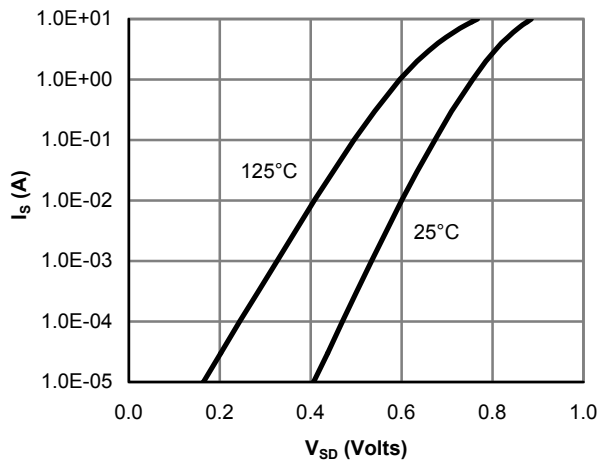


Figure 6: Body-Diode Characteristics

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■ Typical Characteristics

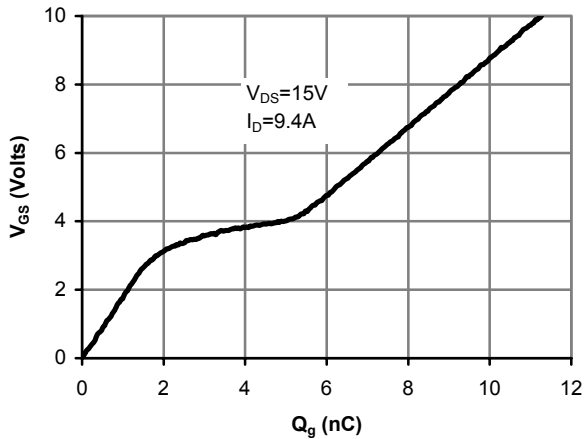


Figure 7: Gate-Charge Characteristics

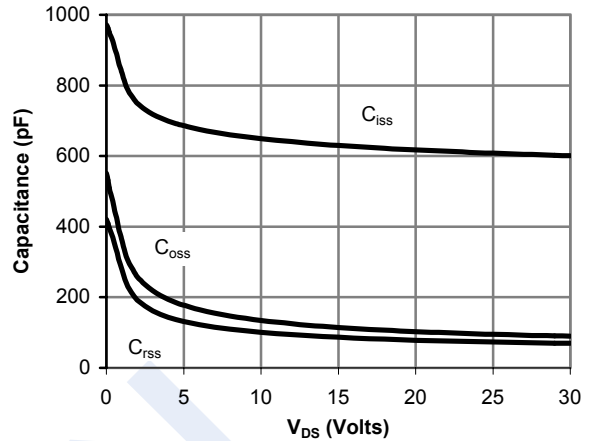


Figure 8: Capacitance Characteristics

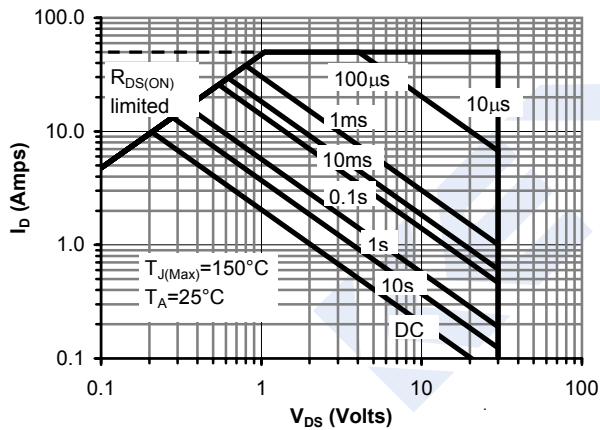


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

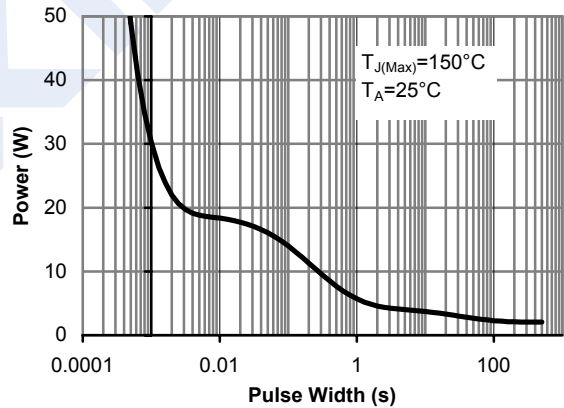


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

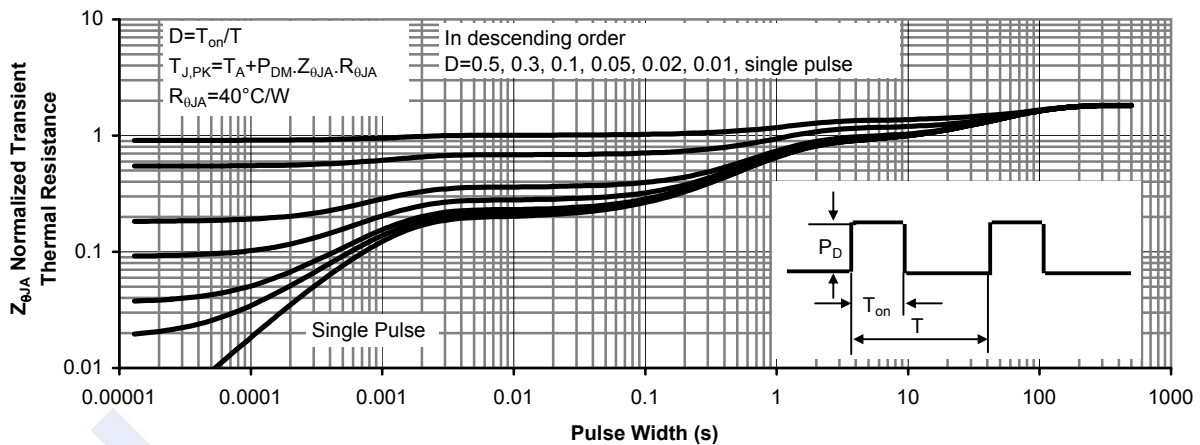


Figure 11: Normalized Maximum Transient Thermal Impedance